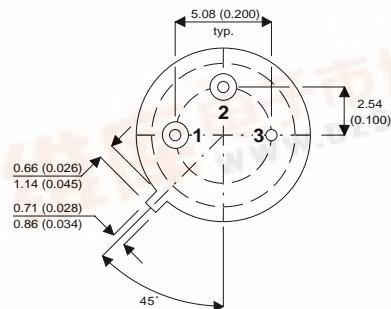
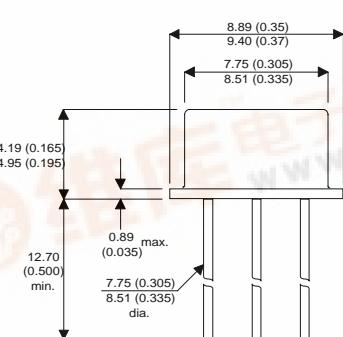




2N6661

MECHANICAL DATA

Dimensions in mm (inches)

**TO-39 METAL PACKAGE****Underside View**PIN 1 – Source
PIN 2 – GatePIN 3 – Drain
CASE – Drain

N-CHANNEL ENHANCEMENT MODE MOS TRANSISTOR

FEATURES

- Switching Regulators
- Converters
- Motor Drivers

ABSOLUTE MAXIMUM RATINGS ($T_{CASE} = 25^\circ\text{C}$ unless otherwise stated)

V_{DS}	Drain – Source Voltage	90V
V_{GS}	Gate – Source Voltage	$\pm 20\text{V}$
I_D	Drain Current @ $T_{CASE} = 25^\circ\text{C}$	0.9A
I_D	Drain Current @ $T_{CASE} = 100^\circ\text{C}$	0.7A
I_{DM}	Pulsed Drain Current *	3A
P_D	Power Dissipation @ $T_{CASE} = 25^\circ\text{C}$	6.25W
P_D	Power Dissipation @ $T_{CASE} = 100^\circ\text{C}$	2.5W
T_j	Operating Junction Temperature Range	-55 to 150°C
T_{stg}	Storage Temperature Range	-55 to 150°C
	Lead Temperature (1/16" from case for 10 sec.)	300°C



**SEME
LAB**

2N6661

ELECTRICAL CHARACTERISTICS ($T_{CASE} = 25^\circ\text{C}$ unless otherwise stated)

Parameter	Test Conditions		Min.	Typ.	Max.	Unit
STATIC CHARACTERISTICS						
$V_{(BR)DSS}$	Gate – Source Breakdown Voltage	$V_{GS} = 0\text{V}$	$I_D = 10\mu\text{A}$	90	120	V
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$	$I_D = 1\text{mA}$	0.8	1.6	2
I_{GSS}	Gate – Body Leakage Current	$V_{GS} = \pm 15\text{V}$			± 100	nA
		$V_{DS} = 0\text{V}$	$T_{CASE} = 125^\circ\text{C}$		± 500	
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 90\text{V}$	$V_{GS} = 0\text{V}$		10	μA
		$V_{DS} = 72\text{V}$	$V_{GS} = 0\text{V}$		500	
			$T_{CASE} = 125^\circ\text{C}$			
$I_{D(on)*}$	On-State Drain Current	$V_{DS} = 15\text{V}$	$V_{GS} = 10\text{V}$	1.5	1.8	A
$R_{DS(on)*}$	Drain – Source On Resistance	$V_{GS} = 5\text{V}$	$I_D = 0.3\text{A}$		4.2	5.3
		$V_{GS} = 10\text{V}$			3.6	4
		$I_D = 1\text{A}$	$T_{CASE} = 125^\circ\text{C}$		6.8	9
$V_{DS(on)*}$	Drain – Source On Voltage	$V_{GS} = 5\text{V}$	$I_D = 0.3\text{A}$		1.26	1.6
		$V_{GS} = 10\text{V}$			3.6	4
		$I_D = 1\text{A}$	$T_{CASE} = 125^\circ\text{C}$		6.8	9
g_{FS}^*	Forward Transconductance	$V_{DS} = 10\text{V}$	$I_D = 0.5\text{A}$	170	350	ms
g_{OS}^*	Common Source Output Conductance	$V_{DS} = 10\text{V}$	$I_D = 0.1\text{A}$		225	
DYNAMIC CHARACTERISTICS						
$R_{DS(on)}$	Small Signal Drain – Source On Resistance	$V_{GS} = 10\text{V}$	$I_D = 1\text{A}$		3.6	4
		$f = 1\text{kHz}$				Ω
C_{ds}	Drain – Source Capacitance	$V_{DS} = 24\text{V}$			30	40
C_{iss}	Input Capacitance				35	50
C_{oss}	Output Capacitance		$V_{GS} = 0\text{V}$		15	40
C_{rss}	Reverse Transfer Capacitance		$f = 1\text{MHz}$		2	10
SWITCHING CHARACTERISTICS						
t_{ON}	Turn-On Time	$V_{DD} = 25\text{V}$	$V_{GEN} = 10\text{V}$		6	10
t_{OFF}	Turn-Off Time	$R_L = 23\Omega$	$R_G = 25\Omega$		8	10
		$I_D = 1\text{A}$				

* Pulse Test: $t_p \leq 80 \mu\text{s}$, $\delta \leq 1\%$